#### TOSHIBA Photocoupler Photorelay

# **TLP592G**

#### **Telecommunications**

#### **PBX**

#### Modems

The Toshiba TLP592G consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a six lead plastic DIP package (DIP6).

The TLP592G is a bi-directional switch can replace mechanical relays in many applications.

• 6-pin DIP (DIP6)

• 1-Form-A

• Peak Off-state voltage: 350 V (min)

• Trigger LED current: 3 mA (max)

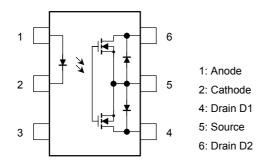
• On-state current: 110 mA (max)

• On-state resistance:  $35 \Omega$  (max, t < 1 s)

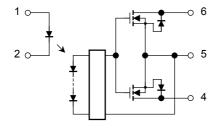
• On-state resistance:  $50 \Omega$  (max, continuous)

• Isolation voltage: 2500 Vrms (min)

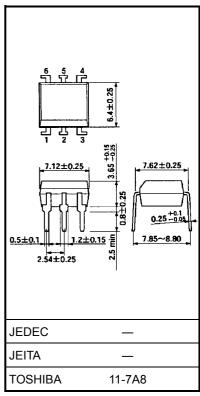
#### Pin Configuration (top view)



### **Schematic**



Unit: mm



Weight: 0.4 g (typ.)

### Maximum Rating (Ta = 25°C)

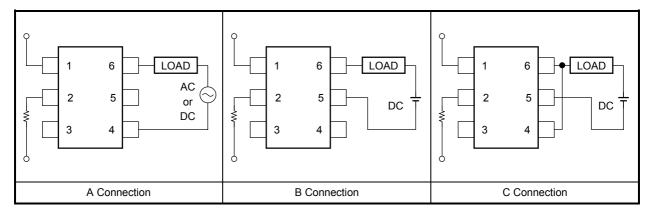
Characteristics			Symbol	Rating	Unit	
	Forward current		l <sub>F</sub>	50	mA	
	Forward current derat (Ta ≧ 25°C)	ing	ΔI <sub>F</sub> /°C	-0.5	mA/°C	
LED	Peak forward current (100 μs pulse, 100 pp	s)	I <sub>FP</sub>	1	А	
	Reverse voltage		$V_{R}$	5	V	
	Junction temperature		Tj	125	°C	
	Off-state output termin	nal voltage	V <sub>OFF</sub>	350	V	
	On-state current	A connection		120	mA	
		B connection	I <sub>ON</sub>	120		
D - 44		C connection		240		
Detector	On-state current derating (Ta ≥ 25°C)	A connection		-1.2		
		B connection	Δl <sub>ON</sub> /°C	-1.2	mA/°C	
	,	C connection		-2.4		
	Junction temperature		Tj	125	°C	
Storage temperature range			T <sub>stg</sub>	T <sub>stg</sub> –55~125		
Operating temperature range			T <sub>opr</sub>	-40~85	°C	
Lead soldering temperature (10 s)			T <sub>sol</sub>	260	°C	
Isolation voltage (AC, 1 min, R.H. ≦ 60%) (Note 1)			BVS	2500	Vrms	

Note 1: Device considered a two-terminal device: LED side pins shorted together, and detector side pins shorted together.

# **Recommended Operating Conditions**

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	$V_{DD}$	_	_	280	V
Forward current	l <sub>F</sub>	5	7.5	25	mA
On-state current	I <sub>ON</sub>	_	_	100	mA
Operating temperature	T <sub>opr</sub>	-20	_	65	°C

#### **Circuit Connections**



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# **Individual Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V		_	10	μΑ
	Capacitance	C <sub>T</sub>	V = 0, f = 1 MHz	_	30	_	pF
Detector	Off-state current	I <sub>OFF</sub>	V <sub>OFF</sub> = 350 V	_	_	1	μΑ
Detector	Capacitance	C <sub>OFF</sub>	V = 0, f = 1 MHz	_	30	_	pF

# **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		I <sub>FT</sub>	I <sub>ON</sub> = 120 mA	_	1	3	mA
Return LED current		I <sub>FC</sub>	I <sub>OFF</sub> = 100 μA	0.1	_	_	mA
	A connection	R <sub>ON</sub>	I <sub>ON</sub> = 120 mA, I <sub>F</sub> = 5 mA, t < 1 s	_	25	35	
On-state	A connection		I <sub>ON</sub> = 120 mA, I <sub>F</sub> = 5 mA	_	35	50	
resistance	B connection		I <sub>ON</sub> = 120 mA, I <sub>F</sub> = 5 mA	_	28	40	Ω
	C connection		I <sub>ON</sub> = 240 mA, I <sub>F</sub> = 5 mA	_	14	20	

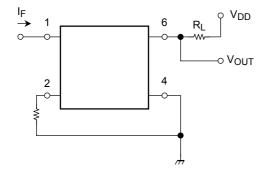
### **Isolation Characteristics (Ta = 25°C)**

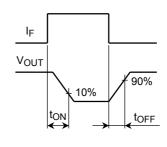
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V <sub>S</sub> = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≦ 60%	$5 \times 10^{10}$	10 <sup>14</sup>	_	Ω
		AC, 1 min	2500	_	_	Vrms
Isolation voltage		AC, 1 s, in oil	_	5000	_	VIIIIS
		DC, 1 min, in oil	_	5000	_	Vdc

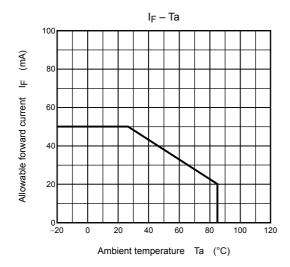
### **Switching Characteristics (Ta = 25°C)**

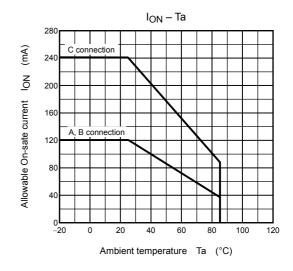
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t <sub>ON</sub>	$R_L = 200 \Omega$	_	0.3	1	ms
Turn-off time	tOFF	$V_{DD}^{-} = 20 \text{ V, I}_{F} = 5 \text{ mA}$ (Note 2)	_	0.1	1	1115

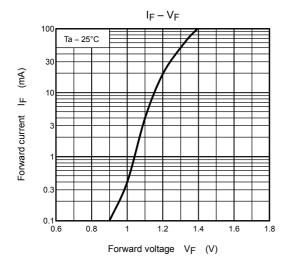
Note 2: Switching time test circuit

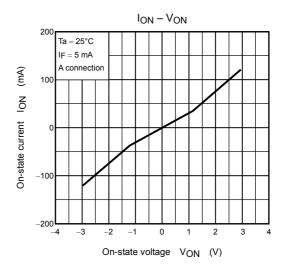


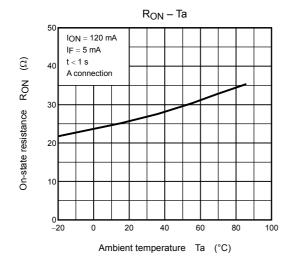


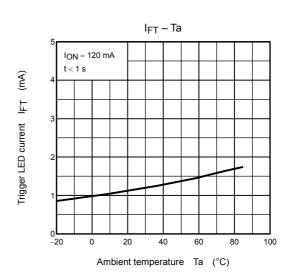


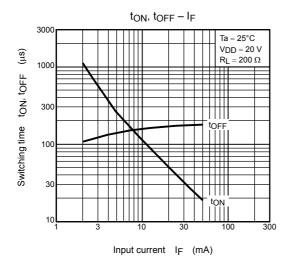


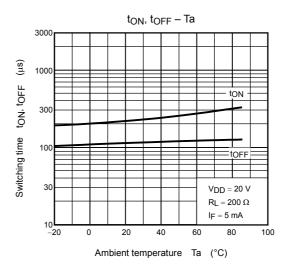


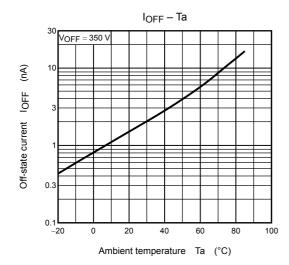












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